

LT3494AEDDB#TRMPBF

Data Sheet

Conv DC-DC 2.3V to 16V Step Up Single-Out 40V Micropower 8-Pin DFN EP T/R

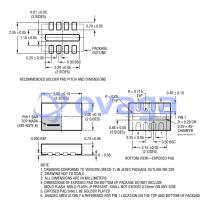
Manufacturers <u>Analog Devices, Inc</u>

Package/Case DFN8

Product Type Power Management ICs

RoHS Pb-free Halide free

Lifecycle



Images are for reference only

Please submit RFQ for LT3494AEDDB#TRMPBF or Email to us: sales@ovaga.com We will contact you in 12 hours.

RFO

General Description

The LT3494/LT3494A are low noise boost converters with integrated power switch, Schottky diode and output disconnect circuitry. The parts use a novel* control technique resulting in low output voltage ripple as well as high efficiency over a wide load current range. This technique guarantees that the switching frequency stays above the audio band for the entire load range. The parts feature a high performance NPN power switch with a 350mA and 180mA current limit for the LT3494A and LT3494 respectively. The quiescent current is a low 65μ A, which is further reduced to less than 1μ A in shutdown. The internal disconnect circuitry allows the output voltage to be isolated from the input during shutdown. An auxiliary reference input (CTRL pin) overrides the internal 1.225V feedback reference with any lower value allowing full control of the output voltage during operation. The LT3494/LT3494A are available in a tiny 8-lead 3mm × 2mm DFN package.

Features Application

Low Quiescent Current OLED Power

Switching Frequency is Non-Audible Over Entire Load Range

Low Noise Power

Integrated Power NPN: MP3 Players

Integrated Schottky Diode

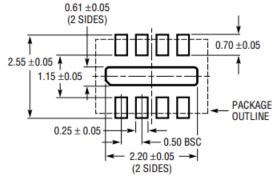
Integrated Output Disconnect

Integrated Output Dimming

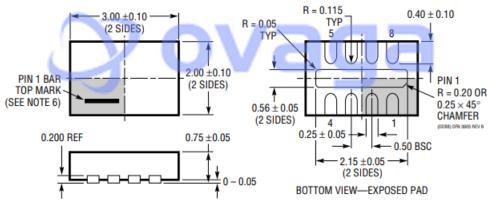
Wide Input Range: 2.3V to 16V

Wide Output Range: Up to 40V

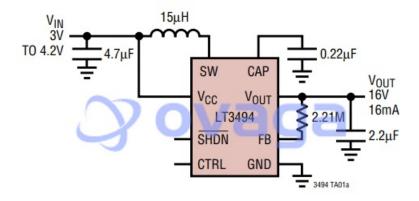
Tiny 8-Lead 3mm × 2mm DFN Package



RECOMMENDED SOLDER PAD PITCH AND DIMENSIONS



- NOTE:
- 1. DRAWING CONFORMS TO VERSION (WECD-1) IN JEDEC PACKAGE OUTLINE M0-229
- 2. DRAWING NOT TO SCALE
- 3. ALL DIMENSIONS ARE IN MILLIMETERS
- DIMENSIONS OF EXPOSED PAD ON BOTTOM OF PACKAGE DO NOT INCLUDE MOLD FLASH. MOLD FLASH, IF PRESENT, SHALL NOT EXCEED 0.15mm ON ANY SIDE
- 5. EXPOSED PAD SHALL BE SOLDER PLATED
- 6. SHADED AREA IS ONLY A REFERENCE FOR PIN 1 LOCATION ON THE TOP AND BOTTOM OF PACKAGE



Related Products



LT3763EFE
Analog Devices, Inc
TSSOP28



LTC4417IUF

Analog Devices, Inc

QFN-24



LTC1966CMS8#PBF
Analog Devices, Inc
MSOP-8P



LTM8045EY#PBF
Analog Devices, Inc
BGA40



LT1038CK
Analog Devices, Inc
TO-3



LTC3440EMS

Analog Devices, Inc

MSOP10



LTC2990IMS#PBF
Analog Devices, Inc
10MSOP



LT42951UFD#PBF
Analog Devices, Inc
28-WFQFN